

# Analog Devices Welcomes Hittite Microwave Corporation

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# HMC429LP4 / 429LP4E

## MMIC VCO w/ BUFFER AMPLIFIER, 4.45 - 5.0 GHz

### Typical Applications

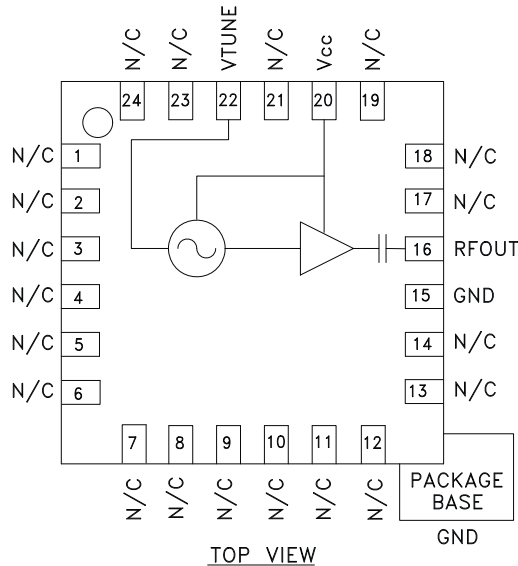
Low noise MMIC VCO w/Buffer Amplifier for:

- 802.11a, HiperLAN WLAN
- VSAT, UNII & Microwave Radio
- Test Equipment & Industrial Controls
- Military

### Features

- Pout: +4.0 dBm
- Phase Noise: -105 dBc/Hz @100 KHz
- No External Resonator Needed
- Single Supply: 3V @ 30 mA
- QFN Leadless SMT Package, 16 mm<sup>2</sup>

### Functional Diagram



### General Description

The HMC429LP4 & HMC429LP4E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs with integrated resonators, negative resistance devices, varactor diodes, and buffer amplifiers. Covering 4.45 to 5.0 GHz, the VCO's phase noise performance is excellent over temperature, shock, vibration and process due to the oscillator's monolithic structure. Power output is 4.0 dBm typical from a single supply of 3.0V @ 30mA. The voltage controlled oscillator is packaged in a low cost leadless QFN 4x4 mm surface mount package.

### Electrical Specifications, $T_A = +25^\circ C$ , $V_{cc} = +3V$

Parameter	Min.	Typ.	Max.	Units
Frequency Range		4.45 - 5.0		GHz
Power Output	1.0	4.0		dBm
SSB Phase Noise @ 100 kHz Offset, $V_{tune} = +5V$ @ RF Output		-105		dBc/Hz
Tune Voltage ( $V_{tune}$ )	0		10	V
Supply Current ( $I_{cc}$ ) ( $V_{cc} = +3.0V$ )		30		mA
Tune Port Leakage Current			10	$\mu A$
Output Return Loss		6		dB
Harmonics				
2nd		-11		dBc
3rd		-23		dBc
Pulling (into a 2.0:1 VSWR)		10		MHz pp
Pushing @ $V_{tune} = +5V$		14		MHz/V
Frequency Drift Rate		0.4		MHz/ $^\circ C$

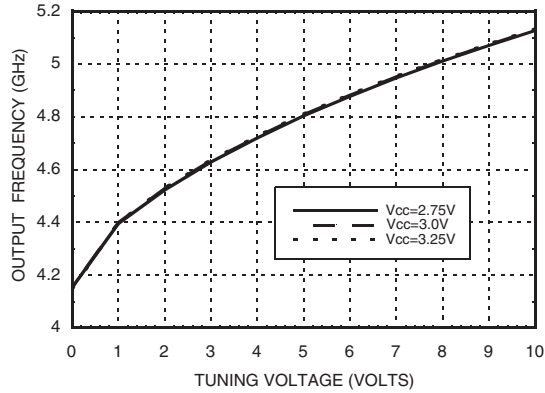
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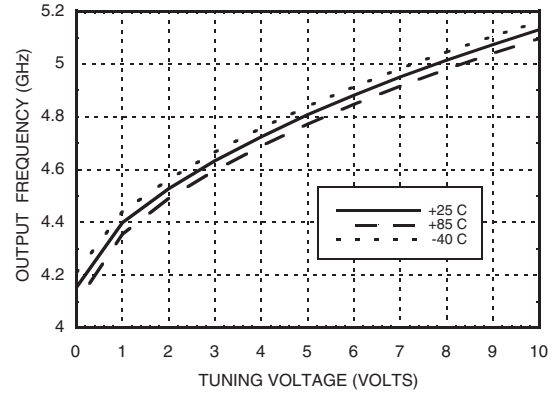
# HMC429LP4 / 429LP4E

## MMIC VCO w/ BUFFER AMPLIFIER, 4.45 - 5.0 GHz

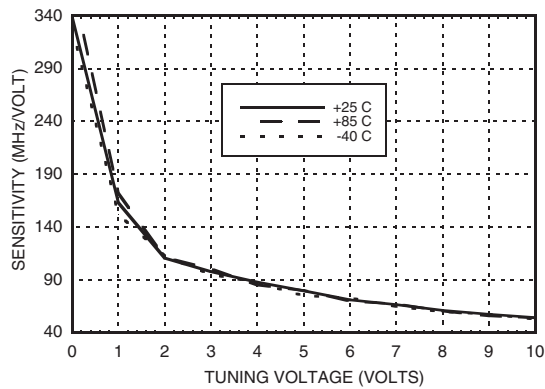
**Frequency vs. Tuning Voltage,  $T = 25^{\circ}\text{C}$**



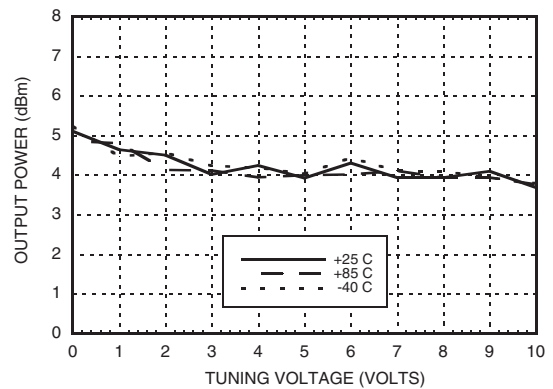
**Frequency vs. Tuning Voltage,  $V_{cc} = +3V$**



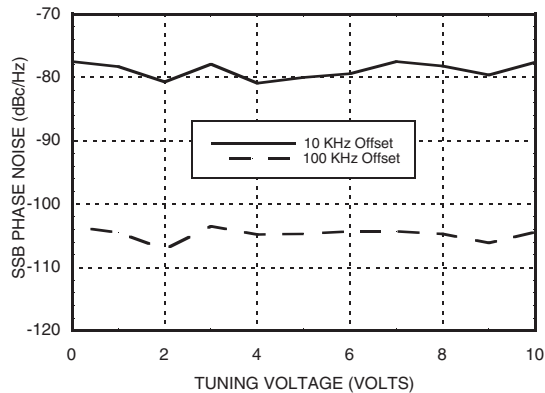
**Sensitivity vs. Tuning Voltage,  $V_{cc} = +3V$**



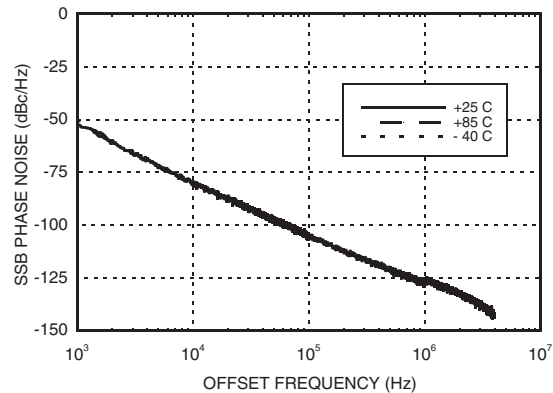
**Output Power vs. Tuning Voltage,  $V_{cc} = +3V$**



**Phase Noise vs. Tuning Voltage**



**Typical SSB Phase Noise @  $V_{tune} = +5V$**



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### Absolute Maximum Ratings

Vcc	+3.5 Vdc
Vtune	0 to +11V
Channel Temperature	135 °C
Continuous P <sub>diss</sub> (T = 85°C) (derate 6.28 mW/°C above 85°C)	565 W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

### Typical Supply Current vs. Vcc

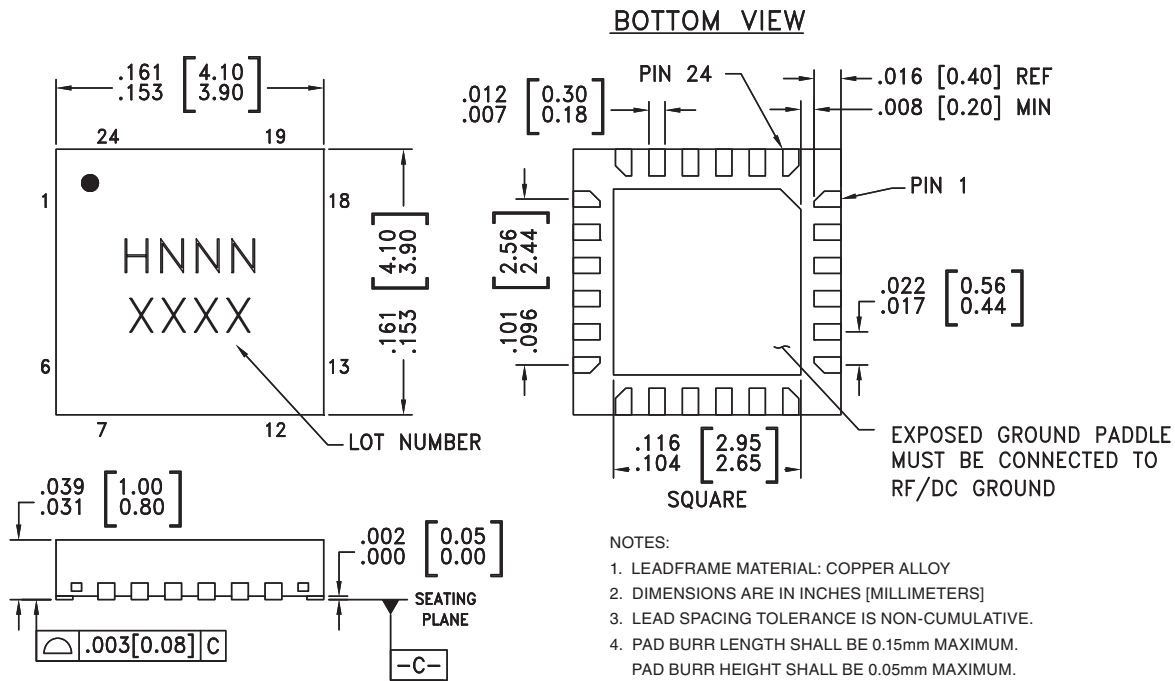
Vcc (V)	Icc (mA)
2.75	21
3.0	30
3.25	38

Note: VCO will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



- NOTES:
1. LEADFRAME MATERIAL: COPPER ALLOY
  2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
  3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
  4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
  5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
  6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
  7. REFER TO HITTITE APPLICATION NOT FOR SUGGESTED LAND PATTERN.

### Package Information


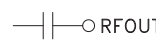
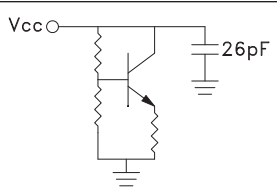
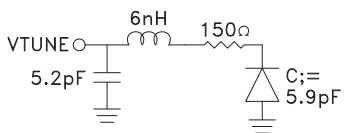

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC429LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H429 XXXX
HMC429LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H429 XXXX

[1] Max peak reflow temperature of 235 °C  
 [2] Max peak reflow temperature of 260 °C  
 [3] 4-Digit lot number XXXX

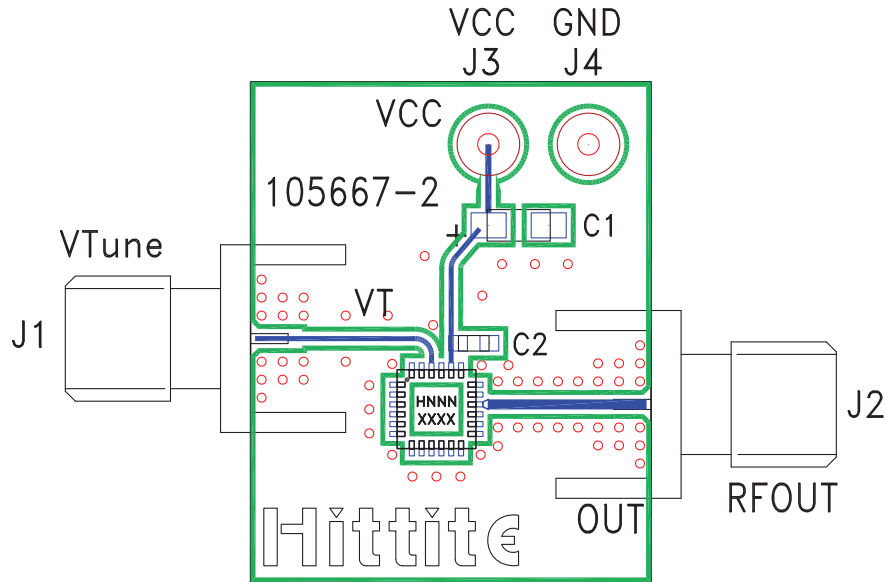
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### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1- 14, 17 - 19, 21, 23, 24	N/C	No Connection	
15	GND	This pin must be connected to RF & DC ground.	
16	RFOUT	RF output (AC coupled)	
20	Vcc	Supply Voltage Vcc= 3V	
22	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	
	GND	Package bottom has an exposed metal paddle that must be RF & DC grounded.	

### Evaluation PCB



### List of Materials for Evaluation PCB 105706 <sup>[1]</sup>

Item	Description
J1 - J2	PCB Mount SMA RF Connector
J3 - J4	DC Pin
C1	4.7 $\mu$ F Tantalum Capacitor
C2	10,000 pF Capacitor, 0603 Pkg.
U1	HMC429LP4 / HMC429LP4E VCO
PCB <sup>[2]</sup>	105667 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





**Notes:**